Frequency Mixer

Level 10 (LO Power +10 dBm) 5 to 3000 MHz

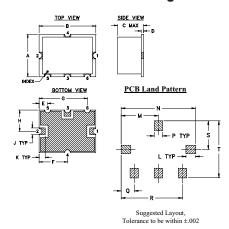
Maximum Ratings

| Operating Temperature | -40°C to 85°C | | | | | | |
|---|----------------|--|--|--|--|--|--|
| Storage Temperature | -55°C to 100°C | | | | | | |
| RF Power | 50mW | | | | | | |
| IF Current | 40mA | | | | | | |
| Permanent damage may occur if any of these limits are exceeded. | | | | | | | |

Pin Connections

| LO | 2 |
|--------|-------|
| RF | 1 |
| IF | 3 |
| GROUND | 4,5,6 |

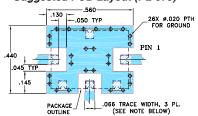
Outline Drawing



Outline Dimensions (inch)

| K | J | Н | G | F | Ε | D | С | В | Α |
|-------|------|-------|-------|-------|------|------|-------|-------|------|
| .050 | .050 | .187 | .425 | .250 | .075 | .020 | .23 | .50 | .38 |
| 1.27 | 1.27 | 4.75 | 10.80 | 6.35 | 1.91 | 0.51 | 5.84 | 12.70 | 9.65 |
| wt. | | Т | S | R | Q | Р | N | М | L |
| grams | 9 | .415 | .208 | .445 | .095 | .060 | .540 | .270 | .070 |
| 0.8 | | 10.54 | 5 28 | 11.30 | 2 41 | 1.52 | 13.72 | 6.86 | 1.78 |

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



- OTE:

 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

 2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.

 3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DEDOTES PCB COPPER LAYDUT WITH SMOBE (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- wideband, 5 to 3000 MHz
- good L-R isolation, 36 dB typ.
- excellent L-I isolation, 45 dB typ.
- low conversion loss, 6.5 dB typ.

Applications

- CDMA
- GSM
- DCS
- PCN

SYM-30DLHW+ **SYM-30DLHW**



CASE STYLE: TTT167

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Electrical Specifications

| FREQU (MI | JENCY Hz) | CON | | SION I dB) | LOSS* | | LO-F | | OLA B) | TION | l | | LO-I | | OLA1 B) | TION | | IP3* at center band |
|---------------|--------------|-----|---------------|---------------|---------------|------|------|------|-----------|------|------|------|------|------|------------|------|------|---------------------------|
| LO/RF | IF | N | /lid-Bai m | nd | Total | | L | N | Л | ι | J | L | - | ľ | Л | ι | J | (dBm) |
| f_L - f_U | | X | σ | Max. | Range Max. | Тур. | Min. | Тур. | Min. | Тур. | Min. | Тур. | Min. | Тур. | Min. | Тур. | Min. | Тур. |
| 5-3000 | 5-1500 | 6.5 | .15 | 8.4 | 9.2 | 36 | 28 | 37 | 29 | 33 | 23 | 41 | 32 | 45 | 37 | 47 | 31 | 19 |

1 dB COMP.: +5 dBm typ. *IP3 at 800-900 MHz. and 1800-1900 MHz

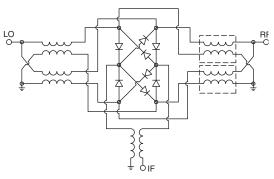
L = low range $[f_L \text{ to } 10 f_L]$ m= mid band $[2f_L \text{ to } f_L/2]$

 $M = mid \ range \ [10 \ f_L \ to \ f_U/2] \qquad U = upper \ range \ [f_U/2 \ to \ f_U]$

Typical Performance Data

| | quency MHz) | ey Conversion Isolation Isolation Loss L-R L-I (dB) (dB) (dB) | | | VSWR VSWI RF Port LO Po (:1) (:1) | | | | |
|--|---|---|---|---|---|--------------------------------------|--|--|--|
| RF | LO | LO +10dBm | LO +10dBm | LO +10dBm | LO +10dBm | LO +10dBm | | | |
| 5.10 100.10 221.15 434.31 647.47 860.63 | 35.11 130.11 251.16 464.32 677.48 890.64 | 6.58 6.53 6.50 6.51 6.40 | 35.88 36.17 36.39 36.54 36.89 | 38.87 43.33 43.27 43.55 43.37 | 1.13 1.08 1.13 1.26 1.43 | 1.62 1.61 1.60 1.57 1.53 | | | |
| 1073.78 1215.89 1429.05 1600.10 | 1103.79 1245.90 1459.06 1630.11 | 6.35 6.36 6.22 6.19 | 38.11 38.74 38.31 37.88 | 47.46 50.49 55.18 58.14 | 1.02 1.76 1.80 1.69 1.50 | 1.30 1.46 1.44 1.37 1.33 | | | |
| 1815.49 2030.87 2246.25 2353.95 2461.64 | 1845.50 2060.88 2276.26 2383.96 2491.65 | 6.36 6.80 7.17 7.26 7.28 | 35.43 32.79 31.15 30.54 30.28 | 54.55 49.03 51.13 54.00 53.61 | 1.29 1.27 1.32 1.27 1.17 | 1.22 1.13 1.04 1.01 1.07 | | | |
| 2569.33 2677.02 2784.72 2892.41 3000.10 | 2599.34 2707.03 2814.73 2922.42 3030.11 | 7.27 7.33 7.43 7.53 7.67 | 30.13 30.10 30.14 30.39 32.41 | 51.62 48.05 46.47 43.08 40.55 | 1.03 1.13 1.29 1.45 1.57 | 1.15 1.24 1.33 1.43 1.51 | | | |

Electrical Schematic

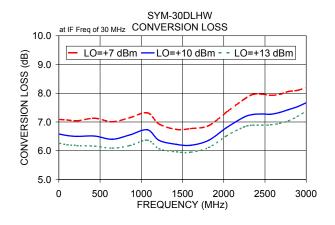


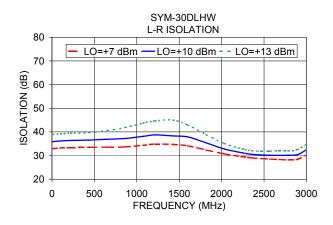
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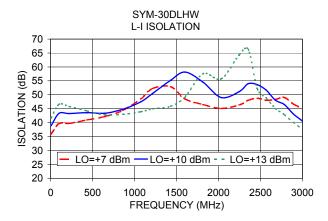
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

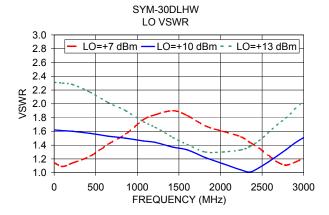
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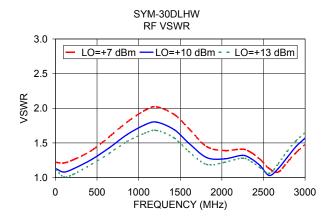
SYM-30DLHW+ SYM-30DLHW

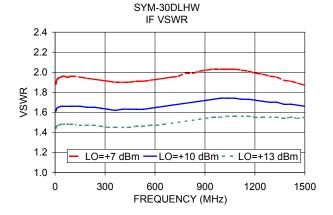












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